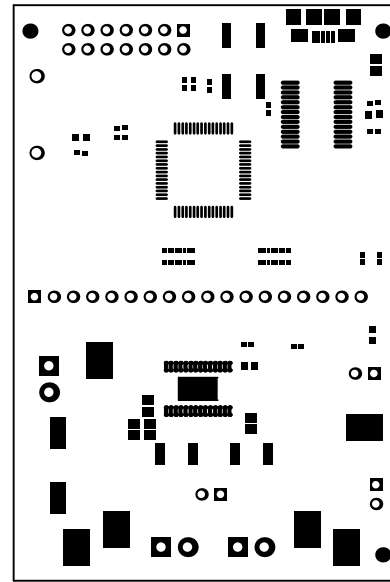
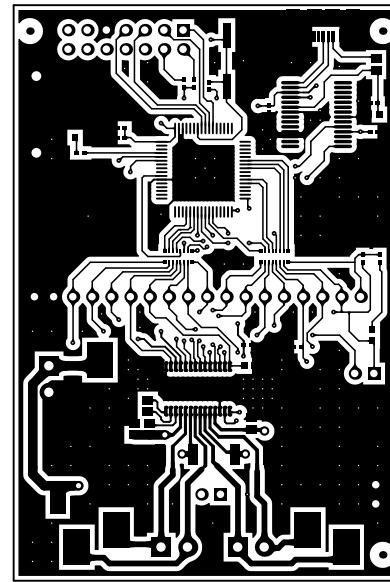


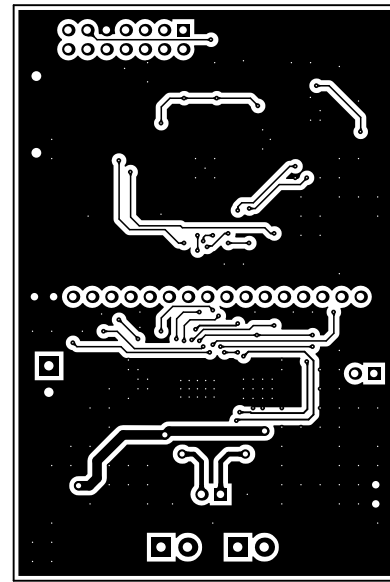
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: 00830	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: TIDA-00830		
PLOT NAME = Top Overlay	GENERATED : 11/9/2015 10:27:56 AM	TEXAS INSTRUMENTS	



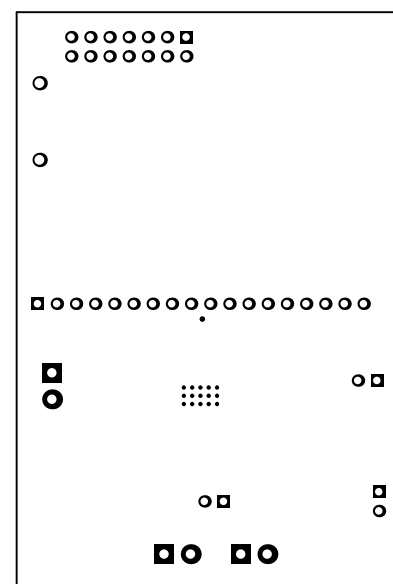
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: 00830	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: TIDA-00830		
PLOT NAME = Top Solder Mask	GENERATED : 11/9/2015 10:27:57 AM	TEXAS INSTRUMENTS	



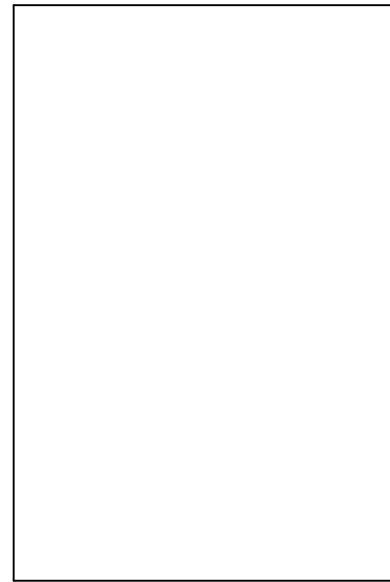
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: 00830	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: TIDA-00830		
PLOT NAME = Top Layer	GENERATED : 11/9/2015 10:27:58 AM	TEXAS INSTRUMENTS	



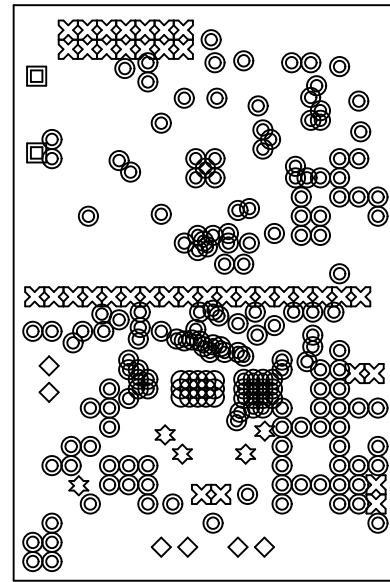
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: 00830	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: TIDA-00830		
PLOT NAME = Bottom Layer	GENERATED : 11/9/2015 10:27:59 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: 00830	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: TIDA-00830		
PLOT NAME = Bottom Solder Mask	GENERATED : 11/9/2015 10:27:59 AM	TEXAS INSTRUMENTS	

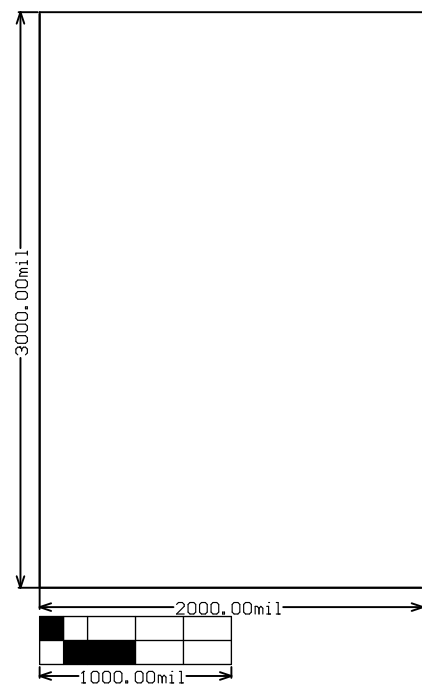


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: 00830	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: TIDA-00830		
PLOT NAME = Bottom Overlay	GENERATED : 11/9/2015 10:28:00 AM	TEXAS INSTRUMENTS	



Symbol	Quantity	Finished Hole Size	Plated	Hole Type
○	15	7.87mil (0.200mm)	PTH	Round
●	181	8.00mil (0.203mm)	PTH	Round
☆	5	28.00mil (0.711mm)	PTH	Round
⊗	38	40.00mil (1.016mm)	PTH	Round
◇	6	50.00mil (1.270mm)	PTH	Round
■	2	51.18mil (1.300mm)	PTH	Round
	247 Total			

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: 00830	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: TIDA-00830		
PLOT NAME = Drill Drawing	GENERATED : 11/9/2015	10:28:01 AM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: 00830	REV: A	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: TIDA-00830		
PLOT NAME = Board Dimensions	GENERATED : 11/9/2015 10:28:02 AM	TEXAS INSTRUMENTS	

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